

[54] MODULAR HOUSING FOR ELECTRONIC SYSTEM

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[**] Term: 14 Years

[21] Appl. No.: 779,650

[22] Filed: Sep. 24, 1985

[52] U.S. Cl. D14/40; D14/102

[58] Field of Search D14/100, 102, 107, 108, D14/109; D13/40, 41; 361/331, 380, 381, 390, 392; 364/708

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[57] CLAIM

The ornamental design for the modular housing for electronic systems, as shown.

DESCRIPTION

FIG. 1 is a top, front, right side perspective view of a modular housing for electronic systems showing my new design;

FIG. 2 is a right side elevational view thereof, the left side being a mirror image;

FIG. 3 is a front elevational view thereof;

FIG. 4 is a rear elevational view thereof;

FIG. 5 is a top plan view thereof;

FIG. 6 is a bottom plan view thereof.

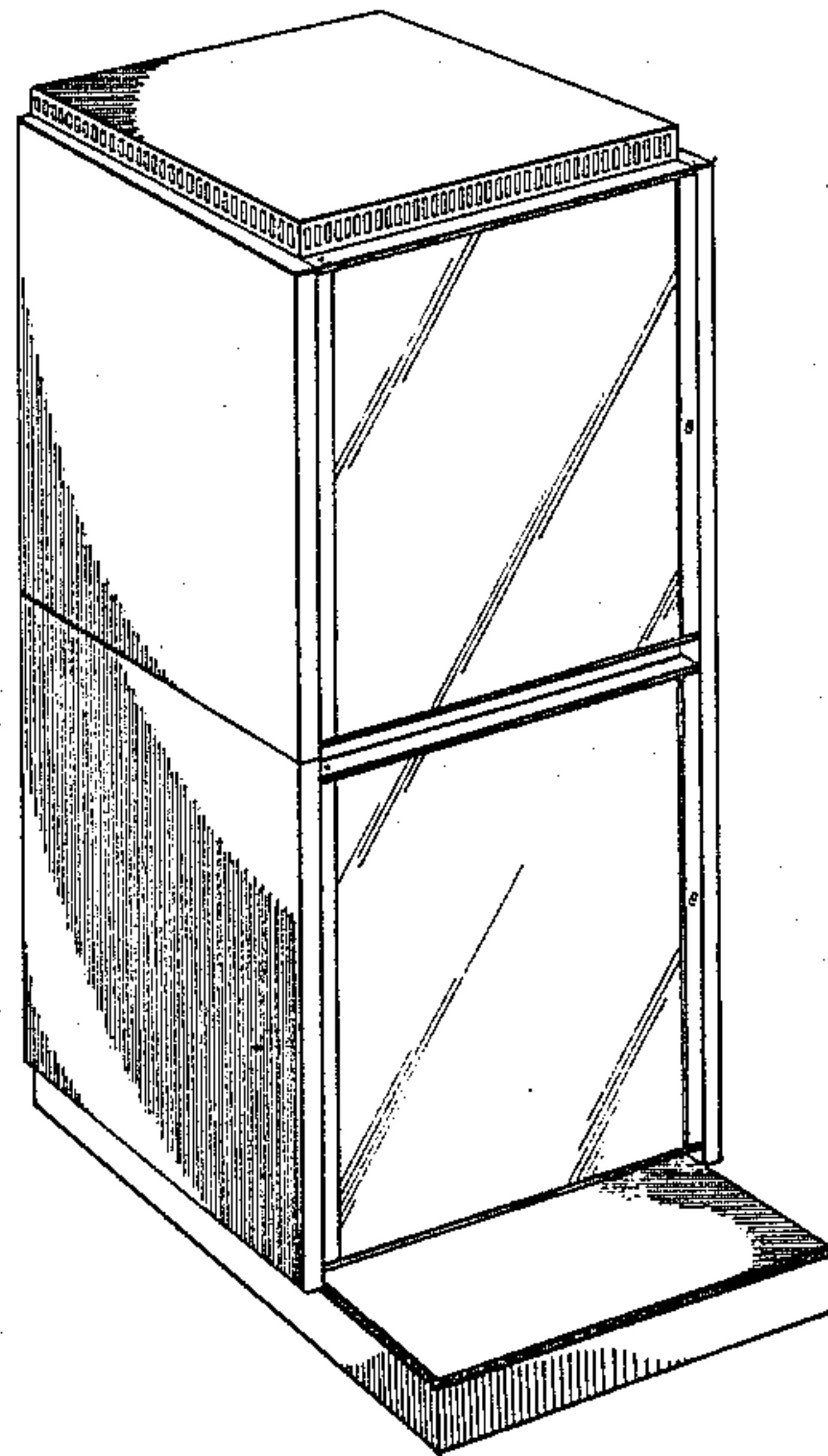


Fig. 1

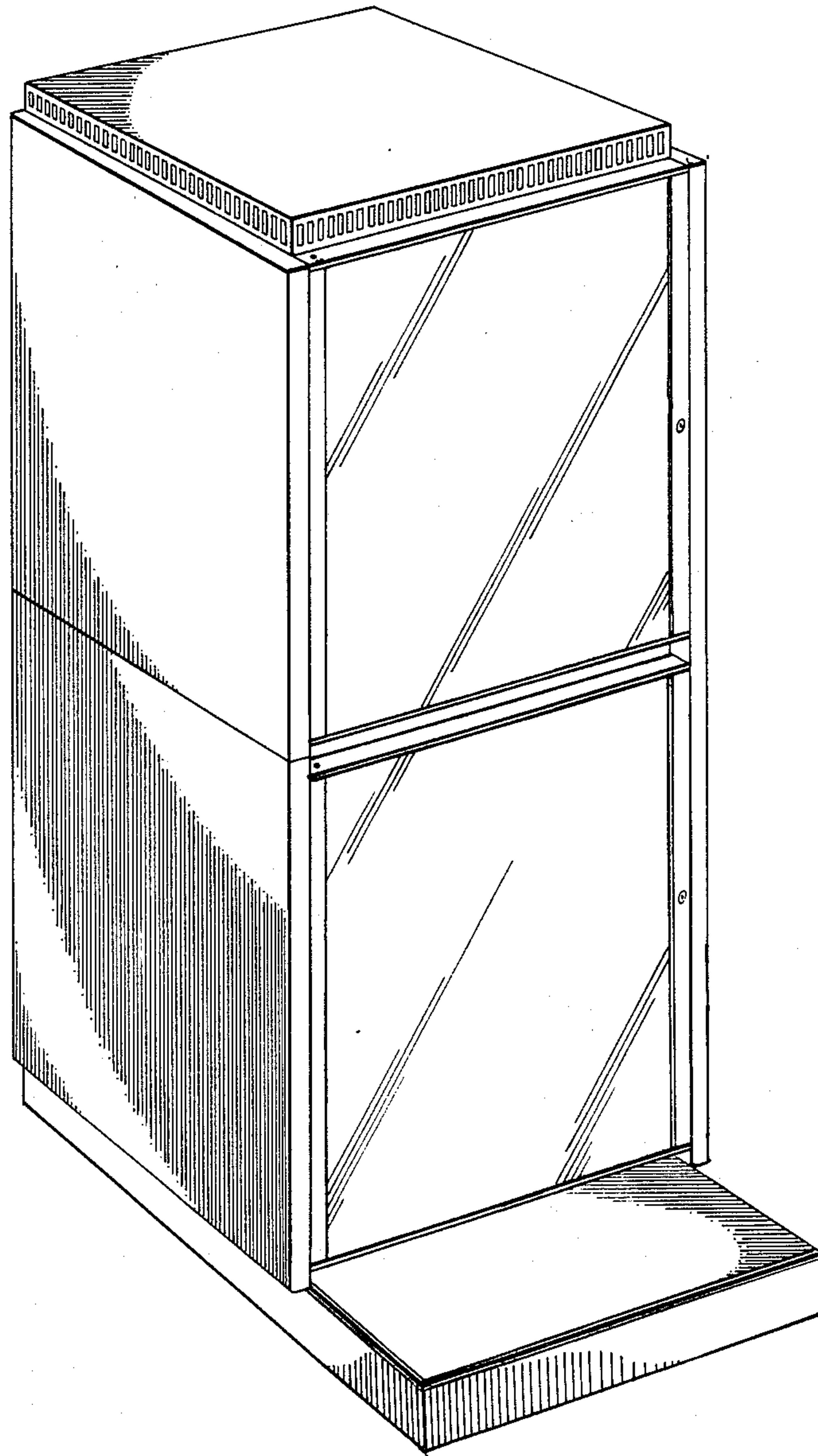


Fig. 2

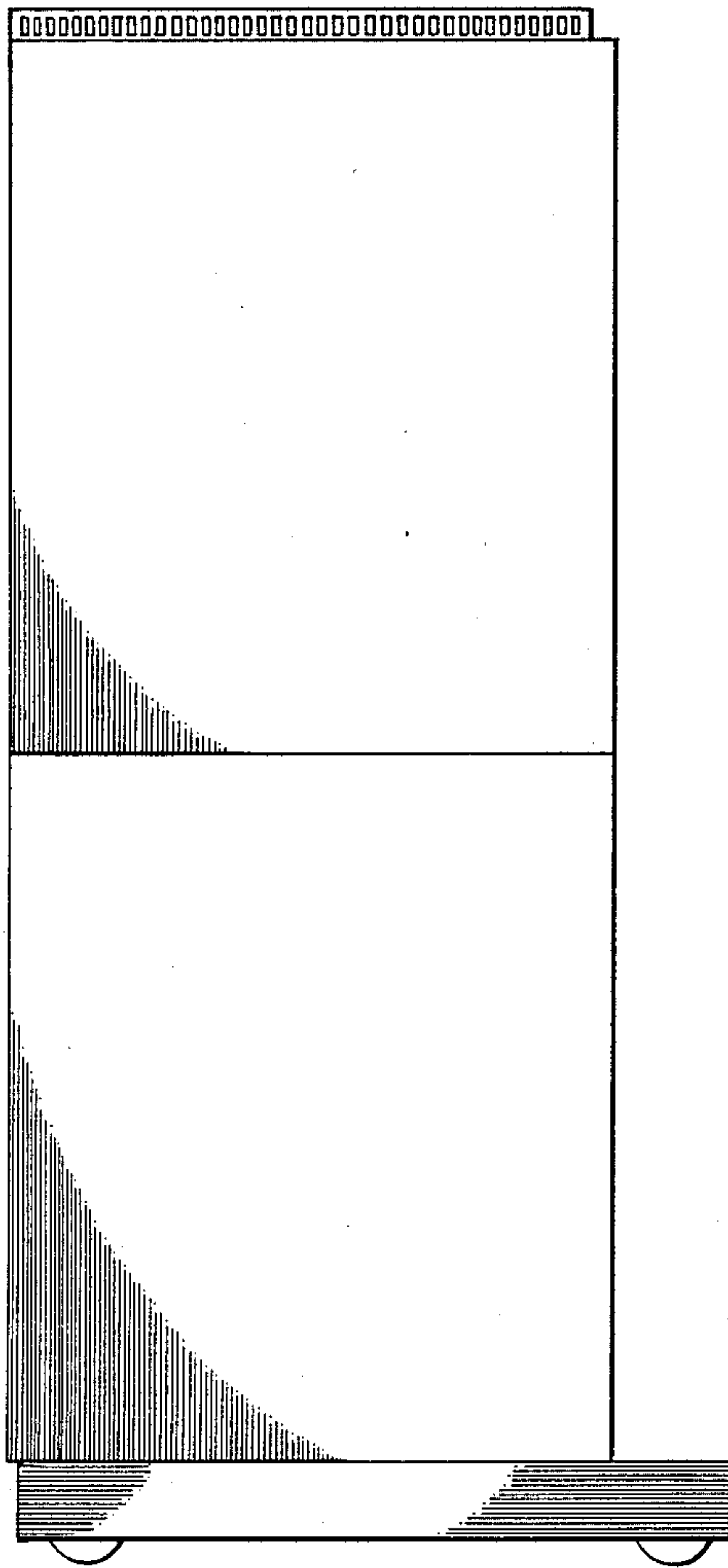


Fig. 5

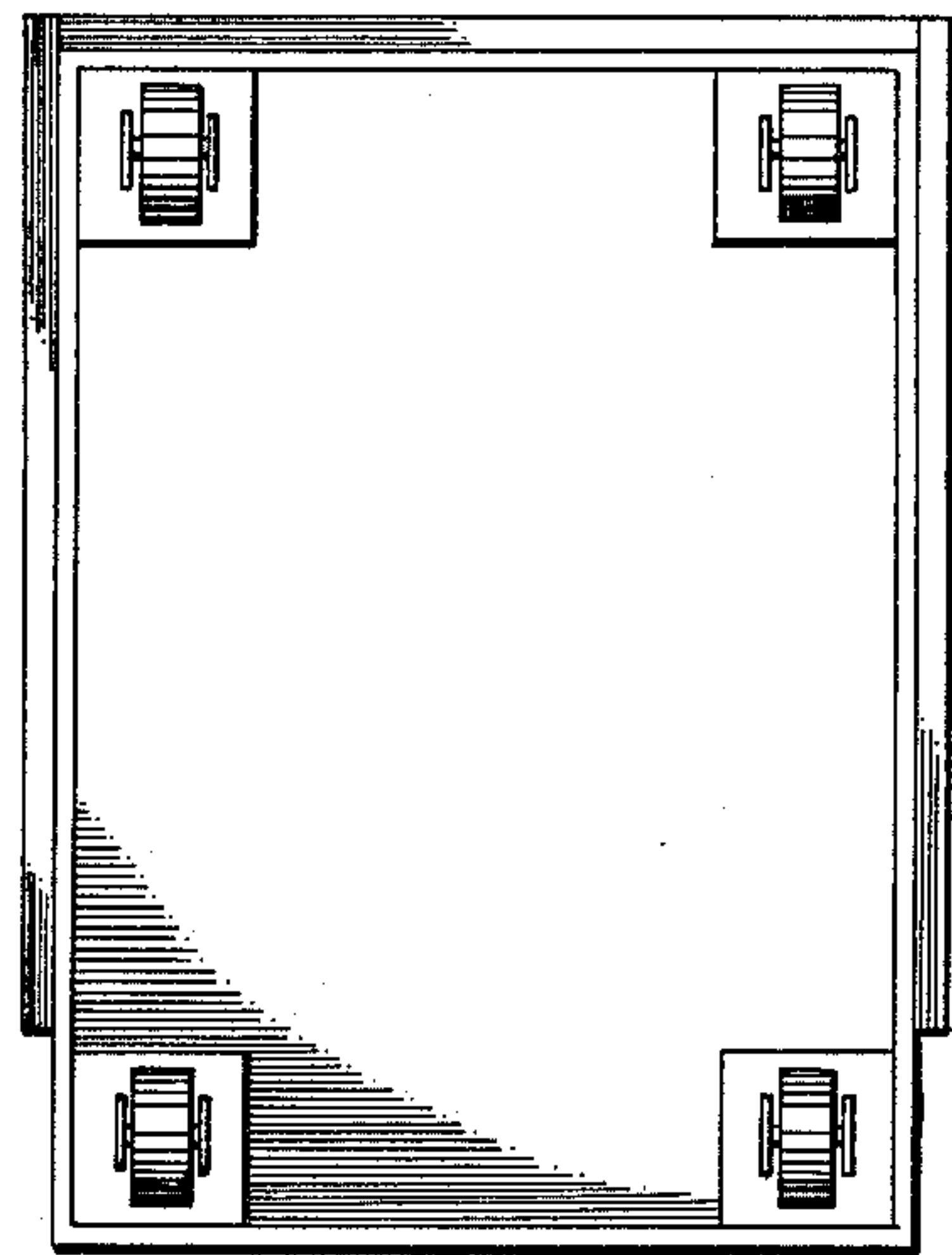
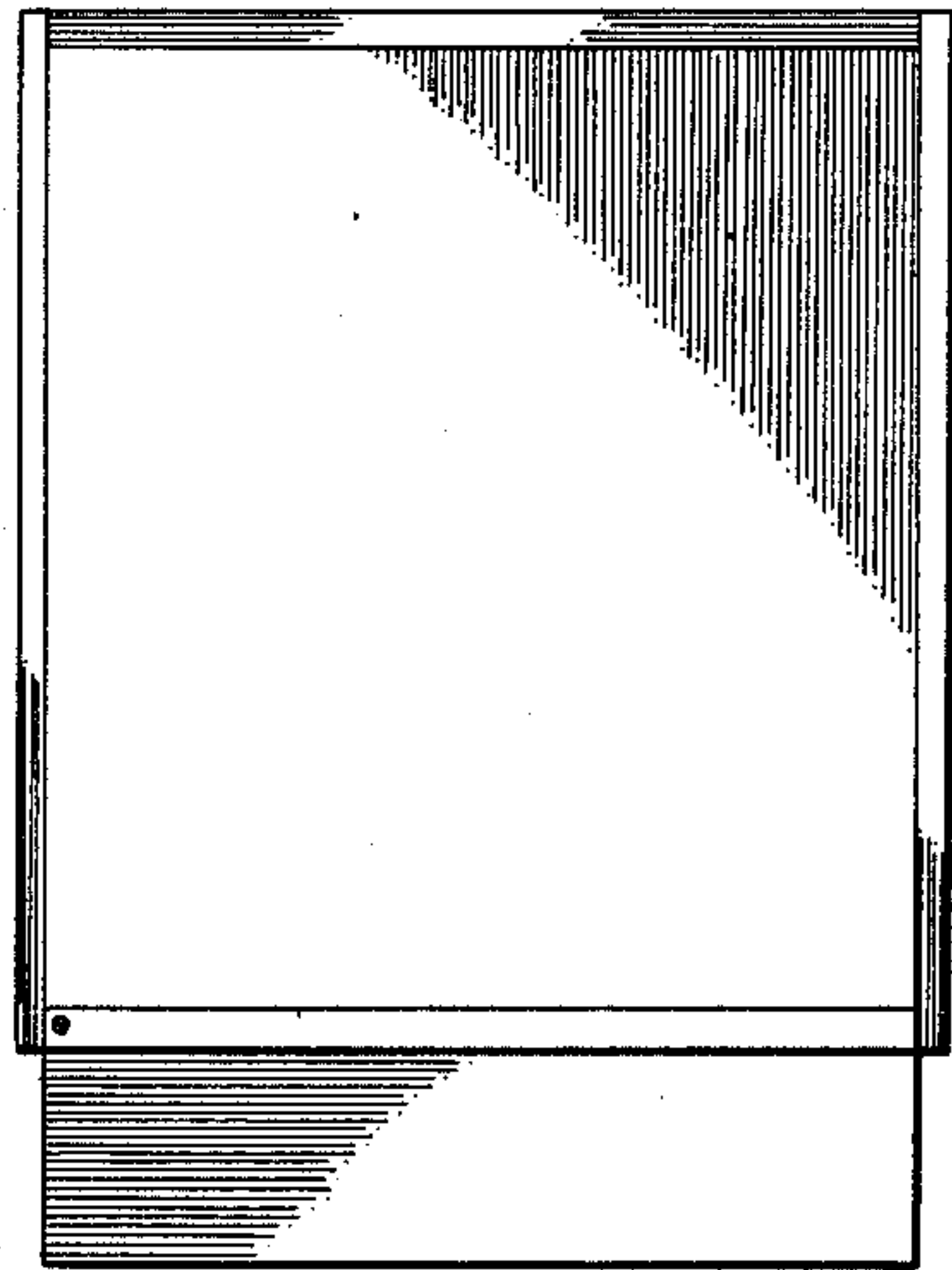


Fig. 6

Fig. 3

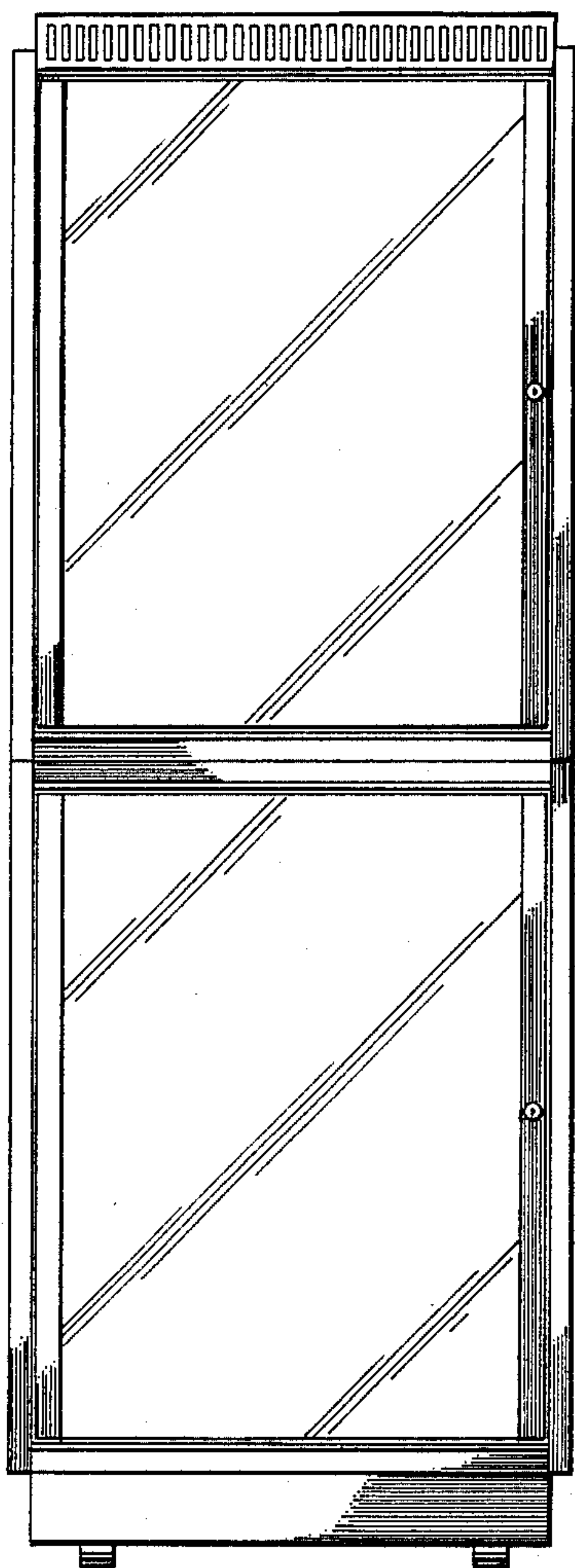


Fig. 4

